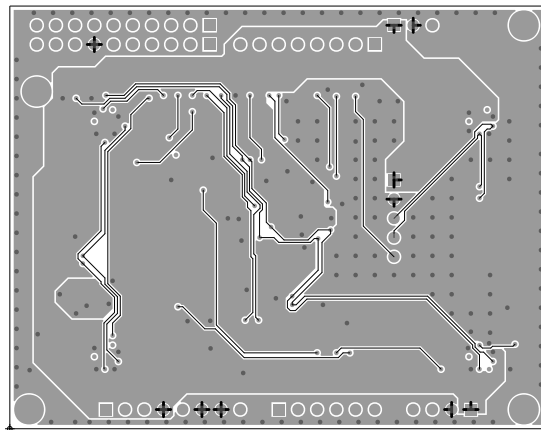


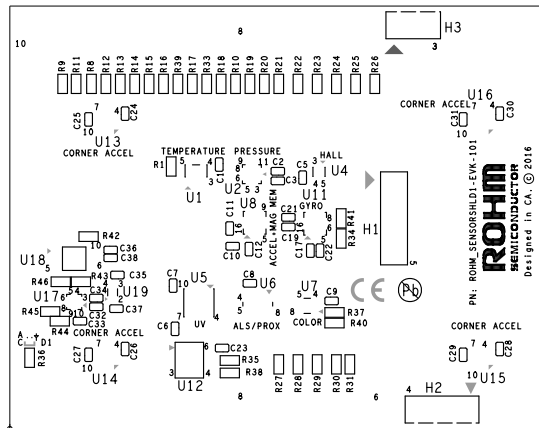
<div>ROHM</div> <div>SEMICONDUCTOR</div>	LAYER: 01 PRIMARY-SIDE		COMPANY NAME: ROHM SEMICONDUCTOR USA		UNLESS OTHERWISE SPECIFIED DIMENSIONS ARE IN INCHES TOLERANCES DECIMAL ANGLE X ± .1 ± 30 XX ± .03 MACH FINIS XXX ± .010 ✓
	DESIGNER: PTEC		PROJECT NAME:		
	CHECKER: ROHM SEMICONDUCTOR		SENSORSHLD1-EVK-101		
	DATE: 2016-03-24		PROJECT NUMBER:		
	JOB#:		NUMBER		
				REV. 01	

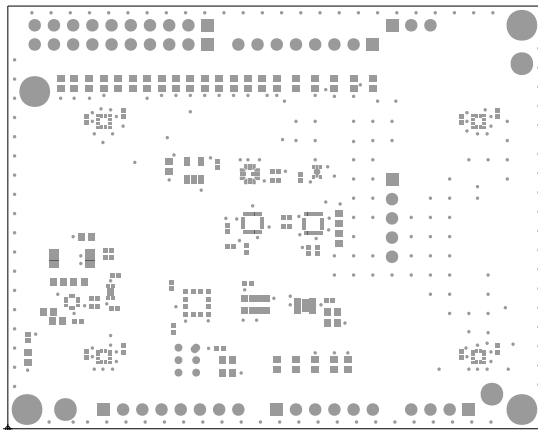


ROHM SEMICONDUCTOR	JOB#:		DATE: 2018-03-24		CHECKER: ROHM SEMICONDUCTOR		DESIGNER: PTEC		SECONDARY-SIDE		LAYER: 02	
	PROJECT NUMBER:		PROJECT NAME:		ROHM SEMICONDUCTOR USA		COMPANY NAME:		UNLESS OTHERWISE SPECIFIED DIMENSIONS ARE IN INCHES			
	NUMBER		SENSORSHLDI-EVK-101		REV.							
	01											

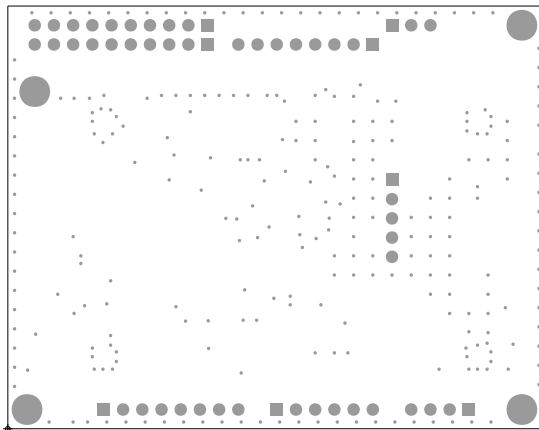
TOLERANCES	DECIMAL	ANGLES	MACH FINISH
	XX ± .03	XX ± 1	XX ± 30
	XXX ± .010		✓

TOLERANCES
 DECIMAL
 ANGLES
 HOLE
 FINISH
 XXX-010
 XX±.03
 MACH
 ±.30
 ±.1
 ±.1






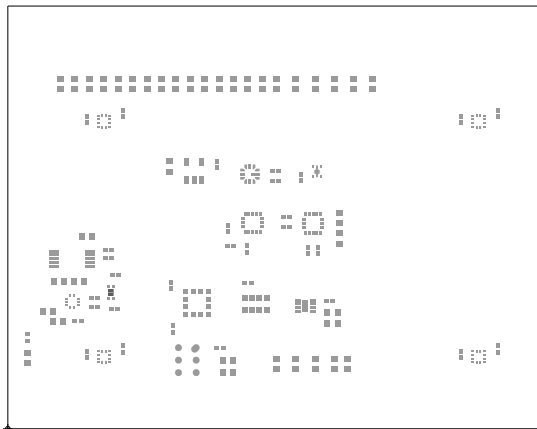
<div>ROHM</div> <div>SEMICONDUCTOR</div>	SOLDERMASK PRIMARY-SIDE	COMPANY NAME : ROHM SEMICONDUCTOR USA		UNLESS OTHERWISE SPECIFIED DIMENSIONS ARE IN INCHES TOLERANCES DECIMAL ANGLE X ± .1 ±30 XX ± .03 MACH FINISH XXX ± .010 ✓
	DESIGNER : PTEC	PROJECT NAME :		
	CHECKER : ROHM SEMICONDUCTOR	SENSORSHLD1-EVK-101		
	DATE : 2016-03-24	PROJECT NUMBER :	REV.	
	JOB# :	NUMBER	01	



ROHM
SEMICONDUCTOR

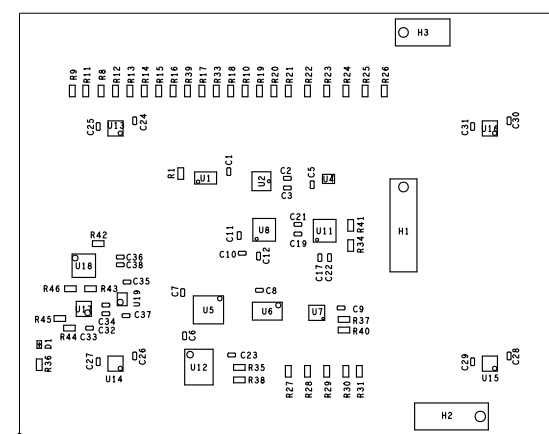
	JOB#:			
	DATE: 2018-03-24			
	CHECKER: ROHM SEMICONDUCTOR			
	DESIGNER: PTEC			
	SECONDARY - SIDE			
SOLDERMASK				
COMPANY NAME: ROHM SEMICONDUCTOR USA				
UNLESS OTHERWISE SPECIFIED DIMENSIONS ARE IN INCHES				

TOLERANCES DECIMAL X ± 1 XX ± 0.03 XXX ± 0.10 MACH FINISH ✓	REV. 01	PROJECT NUMBER: 01	SENSORSHLDI-EVK-101	PROJECT NAME:
	NUMBER		PROJECT NAME:	




<div>ROHM</div> <div>SEMICONDUCTOR</div>	PASTEMASK PRIMARY-SIDE	COMPANY NAME: ROHM SEMICONDUCTOR USA		UNLESS OTHERWISE SPECIFIED DIMENSIONS ARE IN INCHES TOLERANCES DECIMAL ANGLE X ± .1 ±30 XX ± .03 MACH FINISH XXX ± .010 ✓
	DESIGNER: PTEC	PROJECT NAME:		
	CHECKER: ROHM SEMICONDUCTOR	SENSORSHLD1-EVK-101		
	DATE: 2016-03-24	PROJECT NUMBER:	REV.	
	JOB#:	NUMBER	01	

REVISIONS			
REV	DESCRIPTION	DATE	APPROVED



ASSEMBLY
PRIMARY-SIDE

	ASSEMBLY TOP		COMPANY NAME: ROHM SEMICONDUCTOR USA		UNLESS OTHERWISE SPECIFIED DIMENSIONS ARE IN INCHES TOLERANCES DECIMAL ANGLE XXX ± .01 MACH FINISH XXX ± .010
	DESIGNER: PTEC		PROJECT NAME: SENSORSHLD1-EVK-1101		
	CHECKER: INITIAL		ASSEMBLY NUMBER:		
	DATE: 2016-03-24		REV. SHEET: 1 OF 2		
	JOB#:		NUMBER		

4

3

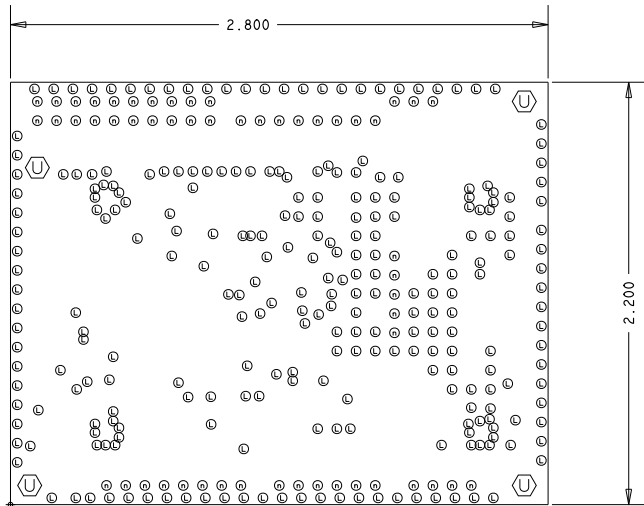
2

1

LAYER STACKING DETAIL

Layer #	Layer Type	Copper Weight (Oz)	Copper Thickness (Mils)	Material Type - Ply	Dielectric Thickness (Mils)
Plating			1.35		
1	SIG	0.5	0.65		
				Prepreg	58.00
2	SIG	0.5	0.65		
Plating			1.35		

Total Overall Thickness: 62.00+/-10%Mils
Material Ordering Info (used in lieu of Fasttrak data)
Panel Size -----
Number Up -----
Number of Parts Due -----
Prepregs Construction Added? -----
Material Ply Specified -----
Material Type (ie Nelco-29, 370 HR, ...) FR4



FAB NOTE

DRILL CHART: TOP to BOTTOM				
ALL UNITS ARE IN MILS				
FIGURE	SIZE	TOLERANCE	PLATED	QTY
•	12.0	+3.0/-10.0	PLATED	264
◦	40.0	+3.0/-3.0	PLATED	54
⊕	125.0	+3.0/-3.0	PLATED	4

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NOTES:

- Specifications.
 - Fabricate IAW IPC600, latest revision.
 - Producibility study - It is the responsdibility of the supplier to conduct a thorough review of the artwork and media for manufacturability in the supplier's process compliance to all applicable specifications. Customer must be advised in writing (in advance of manufacturing) of any changes, revisions, or corrections made or recommendations to ensure conformance to standards, and of any specifications that cannot be met.
 - This drawing is to be used in conjunction with the provided gerber and drill data when applicable.
 - All notes are "Unless Otherwise Specified."
- Material
 - FR4.
 - Color to be opaque.
- Soldermask

Solder mask both sides with (green color) liquid photoimageable soldermask, 003 max. thickness.
Soldermask over bare copper.
Soldermask is allowed in via holes.
- Drilling
 - All hole diameters are finished sizes.
 - All hole to be +/- .003 from true position unless otherwise specified.
 - All hole diameters to be +/- .003 unless otherwise specified.
 - An NC drill file has been supplied - see drill table.
- Finish
 - Plate thru with copper .0010 min to .002 max. thickness drill size dimension apply after plating.
 - Use gold immersion over nickel.
 - Finished boards shall not have nicks, scratches, voids, exposed copper, poor plating, all misdrilled holes.
- Silkscreen
 - Silkscreen using white non-conductive epoxy or equivalent (both sides).
 - No silkscreen allowed on exposed lands.
 - Silkscreen must be a minimum of 3mm away form fiducial marks.
 - Minimum clearance between silkscreen legend and vias, pads, or holes to be .005.
 - Silkscreen is allowed in via holes.
- Electrical Test
 - All boards shall be 100% electrically tested for opens/short at 10 volts. MIL-SPEC boards to be tested at 40 volts.
 - Apply test stamp in non-legend area on solder side of PCB.
 - Test is required on both sides of the board.
- Cleanliness
 - Boards shall be free of fiber glass dust or any other foreign material.
 - Finished boards must conform to 0.01 MG/IN max NAcL ionic contamination as measured by the omega meter 600SMD.
- Packaging

There shall be a max of 25 units per package, individually wrapped, and shipped in cardboard cratons with sufficient surrounding material to prevent shipping damage.
- Bow and Twist

Bow and twist to be .007 IN/IN or .090 max according to IPC-A-600D.
- Inspection
 - Automatic optical inspection of all layers required.
 - The impedance should be controlled by stackup layer.
- Inside corners should be rounded-off
- Changes to board geometries and apertures are not allowed unless they are approved by customer.
- Rounding is allowed on 90 degree corners with the size of standard routing bit.

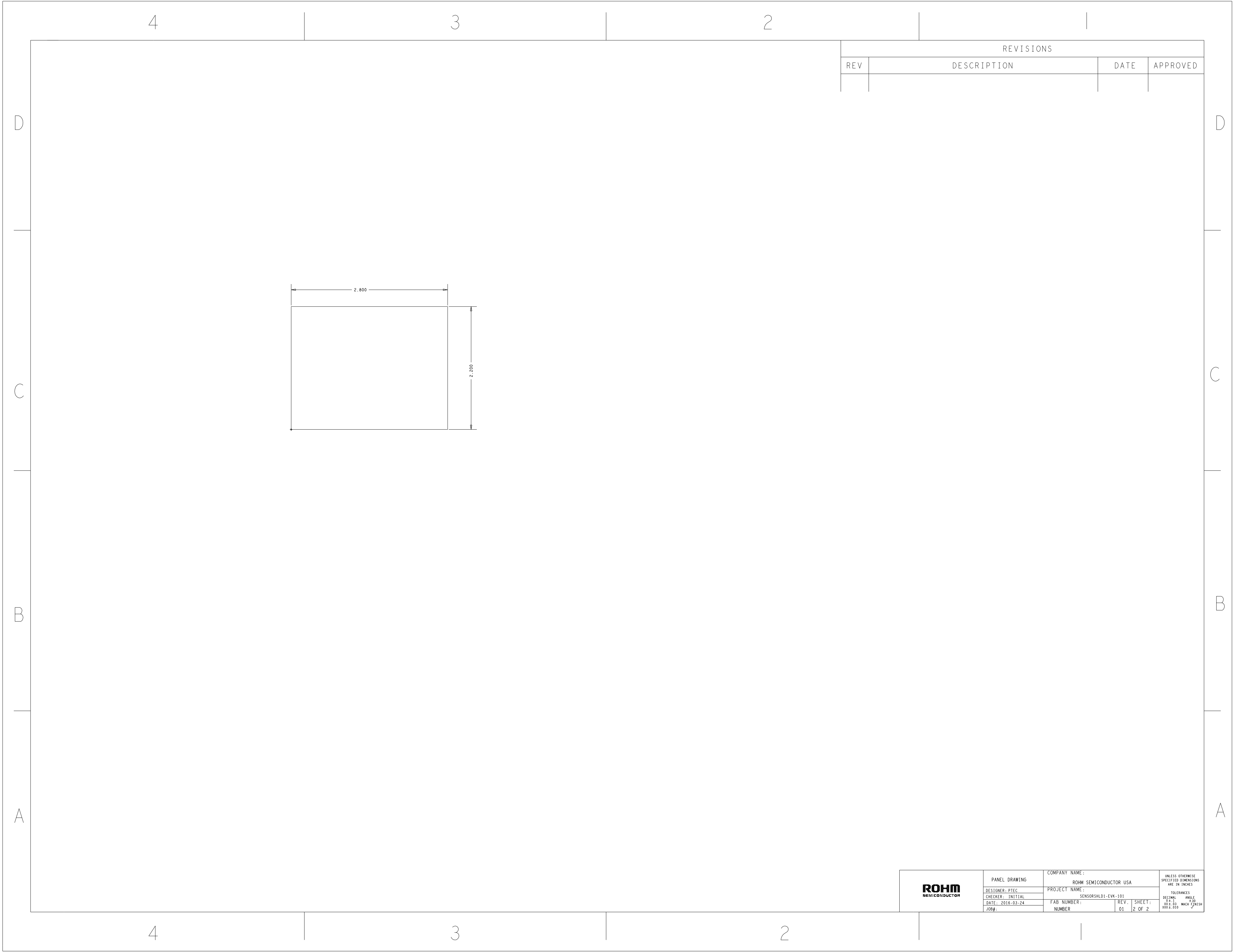
ROHM SEMICONDUCTOR	FAB DRAWING	COMPANY NAME:		UNLESS OTHERWISE SPECIFIED DIMENSIONS ARE IN INCHES	
		ROHM SEMICONDUCTOR USA			
	DESIGNER: PTEC	PROJECT NAME:		TOLERANCES DECIMAL: .010 .020 .030 .050 .100 .150 .200 .250 .300 .375 .500 .625 .750 .875 1.000 1.250 1.500 1.750 2.000 2.500 3.000 3.750 4.000 5.000 6.000 7.000 8.000 9.000 10.000 ANGLE XX ± .03 XXX ± .010	
	CHECKER: INITIAL	SENSORSRLD1-EVK-101			
	DATE: 2016-03-24	FAB NUMBER:	REV.		
JOB#:	NUMBER	01	1 OF 2		

4

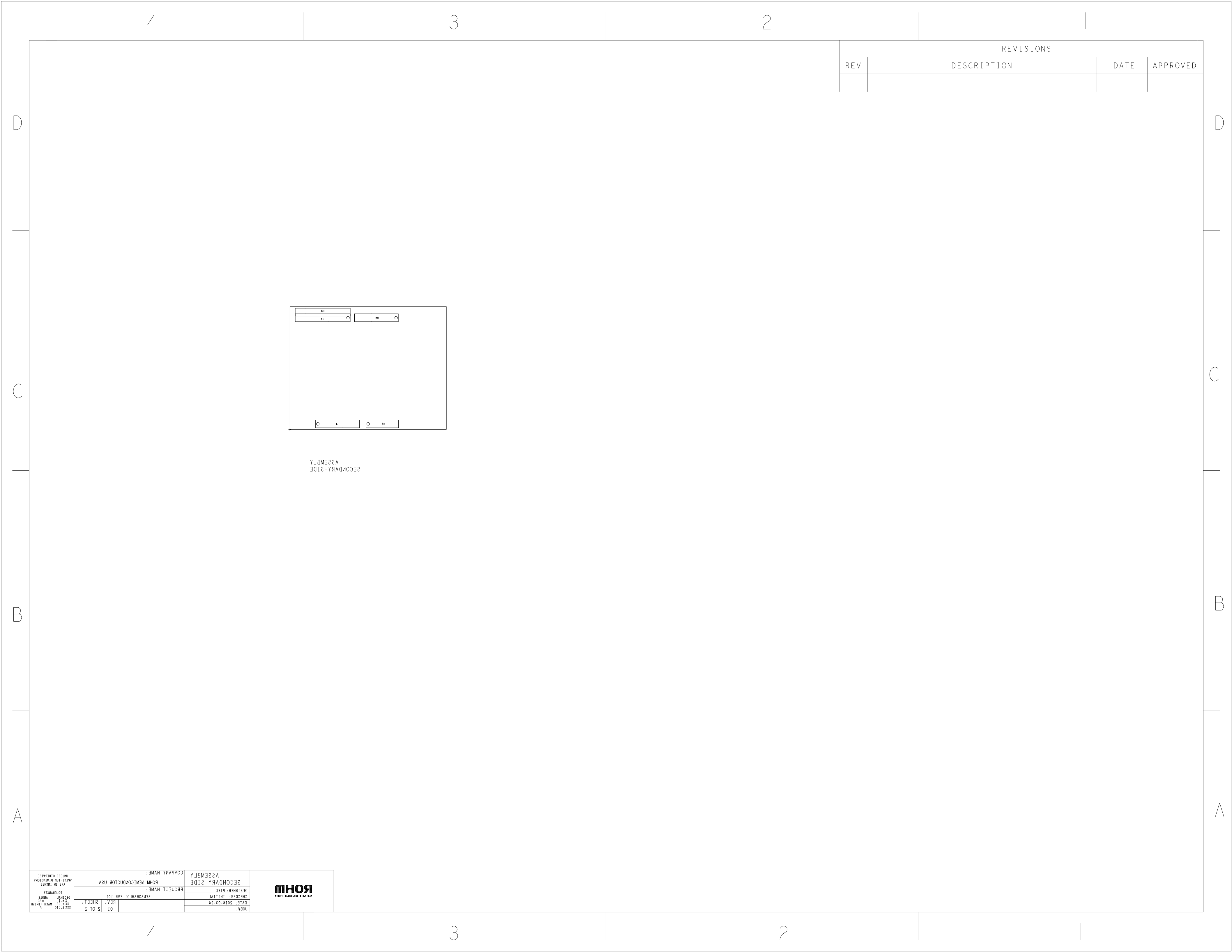
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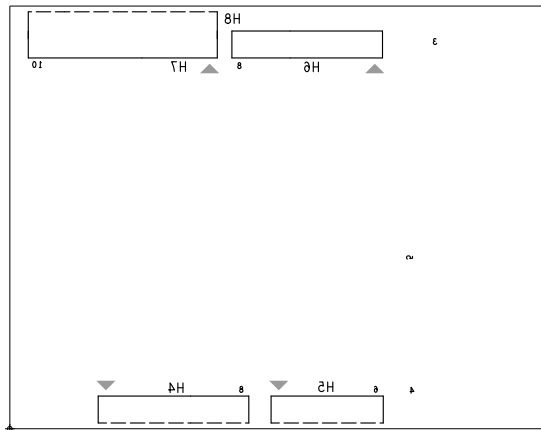


<div>ROHM</div> <div>SEMICONDUCTOR</div>	PANEL DRAWING	COMPANY NAME :			UNLESS OTHERWISE SPECIFIED DIMENSIONS ARE IN INCHES		
	DESIGNER: PTEC	ROHM SEMICONDUCTOR USA					
	CHECKER: INITIAL	PROJECT NAME :			TOLERANCES DECIMALS ANGLES XX ± .01 MAC ± .010		
	DATE: 2016-03-24	SENSORSHLD1-EVK-101					
	JOB#:	FAB NUMBER: NUMBER	REV. 01	SHEET: 2 OF 2			



<div>ROHM SEMICONDUCTOR</div>	COMPANY NAME : ROHM SEMICONDUCTOR USA		PROJECT NAME : A22SEMBLY	
	DESIGNER : JIMMY		CHECKER : JIMMY	
	DATE : 2018-03-24		REV : 01	
	SHEET : 01		S OF S : 01	

REVISIONS			
REV	DESCRIPTION	DATE	APPROVED



<div>ROHM</div> <div>SEMICONDUCTOR</div>	JOB#:		DATE: 2018-03-24		CHECKER: ROHM SEMICONDUCTOR		DESIGNER: PTEC		SECONDARY - SIDE		SILKSCREEN		COMPANY NAME: ROHM SEMICONDUCTOR USA		PROJECT NAME: SENSORSHLDI-EVK-101		REV. 01		TOLERANCES ARE IN INCHES UNLESS OTHERWISE SPECIFIED DIMENSIONS	
	NUMBER		PROJECT NUMBER:		DECIMAL		ANGLE		TOLERANCES		XX ±.03		XX ±.01		XX ±.01		XX ±.01		XX ±.01	
	NUMBER		PROJECT NUMBER:		DECIMAL		ANGLE		TOLERANCES		XX ±.03		XX ±.01		XX ±.01		XX ±.01		XX ±.01	
	NUMBER		PROJECT NUMBER:		DECIMAL		ANGLE		TOLERANCES		XX ±.03		XX ±.01		XX ±.01		XX ±.01		XX ±.01	
	NUMBER		PROJECT NUMBER:		DECIMAL		ANGLE		TOLERANCES		XX ±.03		XX ±.01		XX ±.01		XX ±.01		XX ±.01	